STL8N10F7



N-channel 100 V, 17 mΩ typ., 8 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 3.3x3.3 package

Datasheet - production data



Order code	VDS	RDS(on) max.	ID	Ртот
STL8N10F7	100 V	20 mΩ	8 A	2.9 W

• Among the lowest R_{DS(on)} on the market

- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness

Applications

• Switching applications

Description

This N-channel Power MOSFET utilizes STripFET[™] F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

PowerFLAT™ 3.3x3.3 Figure 1: Internal schematic diagram



Table 1: Device summary

Order code	Marking	Package	Packing
STL8N10F7	8N10F	PowerFLAT™ 3.3x3.3	Tape and reel

1/14

This is information on a product in full production.

Contents

Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	8
4	Packag	e information	9
	4.1	PoweFLAT 3.3x3.3 pakage information	10
5	Revisio	n history	13



1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vds	Drain-source voltage	100	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at T _{pcb} = 25 °C	8	А
اD ⁽¹⁾	Drain current (continuous) at T _{pcb} = 100 °C	6	А
ا _D (2)	Drain current (continuous) at $T_c = 25 \text{ °C}$	35	А
I _D ⁽²⁾	Drain current (continuous) at Tc= 100 °C	22	А
I _{DM} ⁽¹⁾⁽³⁾	Drain current (pulsed)	32	А
I _{DM} ⁽²⁾⁽³⁾	Drain current (pulsed)	140	А
Ртот ⁽²⁾	Total dissipation at $T_c = 25 \ ^{\circ}C$	50	W
Ртот ⁽¹⁾	Total dissipation at $T_{pcb} = 25 \text{ °C}$	2.9	W
T _{stg}	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	-55 to 150	°C

Notes:

 $^{(1)}\mbox{This}$ value is rated according to Rthj-pcb.

 $^{(2)}\mbox{This}$ value is rated according to $R_{\mbox{thj-case}}.$

 $^{\rm (3)}{\rm Pulse}$ width limited by safe operating area.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	2.5	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb 42.8		C/VV

Notes:

 $^{(1)}$ When mounted on FR-4 board of 1inch², 2oz Cu, t < 10 s.



2 Electrical characteristics

(Tc= 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	100			V
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 100 V$			1	μΑ
IDSS	I _{DSS} Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V},$ $T_c = 125 \text{ °C} (1)$			100	μA
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±20 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.5		4.5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4 \text{ A}$		17	20	mΩ

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1640	-	pF
Coss	Output capacitance	V _{DS} = 50 V, f = 1 MHz,	-	360	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	25	-	pF
Qg	Total gate charge	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 8 \text{ A},$	-	25	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 0 to 10 V (see <i>Figure 14: "Test circuit for</i>	-	12	-	nC
Q _{gd}	Gate-drain charge	gate charge behavior")	-	5	-	nC

Table 5: Dynamic

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 4 \text{ A},$	I	15	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 13: "Test circuit for resistive load switching times"	I	17	-	ns
t _{d(off)}	Turn-off-delay time		-	24	-	ns
t _f	Fall time	and Figure 18: "Switching time waveform")	-	8	-	ns

Electrical characteristics

	Table 7: Source-drain diode					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{SD} ⁽¹⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 8 A	-		1.1	V
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	53		ns
Qrr	Reverse recovery charge	$V_{DD} = 80 \text{ V}, \text{ T}_{\text{j}} = 150 ^{\circ}\text{C}$ (see Figure 15: "Test circuit for	-	67		nC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	2.5		A

Notes:

 $^{(1)}\text{Pulse test:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%













STL8N10F7

57

Electrical characteristics







3 Test circuits









4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



4.1 PoweFLAT 3.3x3.3 pakage information



STL8N10F7

7			Package information
Ta	ole 8: PowerFLAT™ 3.3x3	3.3 package mechanic	al data
Dim.		mm	
Dim.	Min.	Тур.	Max.
A	0.70	0.80	0.90
b	0.25	0.30	0.39
С	0.14	0.15	0.20
D	3.10	3.30	3.50
D1	3.05	3.15	3.25
D2	2.15	2.25	2.35
е	0.55	0.65	0.75
E	3.10	3.30	3.50
E1	2.90	3.00	3.10
E2	1.60	1.70	1.80
Н	0.25	0.40	0.55
К	0.65	0.75	0.85
L	0.30	0.45	0.60
L1	0.05	0.15	0.25
L2			0.15
θ	8°	10°	12°



Package information

STL8N10F7





5 Revision history

Table 9: Document revision history

Date	Revision	Changes
31-Jul-2013	1	First release.
05-Dec-2014	2	 Document status promoted from preliminary to production data. Modified title, features and description in cover page. Modified: R_{DS(on)} typical and max values in first page and in <i>Table 4: On/off states</i> Modified: Section 4: Package mechanical data Added Section 2.1: Electrical characteristics (curves).
02-Nov-2017	3	 Datasheet promoted from preliminary data to production data. Modified title, silhouette and features table on cover page. Modified Table 2: "Absolute maximum ratings", Table 4: "Static" and Table 5: "Dynamic". Modified Figure 8: "Capacitance variations", Figure 9: "Normalized gate threshold voltage vs temperature", Figure 10: "Normalized on-resistance vs temperature", Figure 11: "Normalized V_{(BR)DSS} vs temperature" and Figure 12: "Source-drain diode forward characteristics". Updated Section 4: "Package information". Minor text changes.



IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 SPP20N60S5XK FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF